# Ultradur<sup>®</sup> B 4406 PBT (Polybutylene Terephthalate)



# **Product Description**

Ultradur B 4406 is an injection molding PBT grade grade with migration-free flame retardant offering a UL V0 rating.

# Applications

Typical applications include relay housings, plug-in connectors, and switch and lamp parts.

PHYSICAL	ISO Test Method	Property Value
Density, g/cm	1183	1.45
Viscosity Number, cm/g	1628	122
Moisture, %	62	
(50% RH)		0.25
(Saturation)		0.4
RHEOLOGICAL	ISO Test Method	Property Value
Melt Volume Rate (250 C/2.16 Kg), cc/10min.	1133	30
MECHANICAL	ISO Test Method	Property Value
Tensile Modulus, MPa	527	
23C		3,000
Tensile stress at yield, MPa	527	
23C		65
Tensile stress at break, MPa	527	
Tensile strain at yield, %	527	
23C		3.9
Nominal strain at break, %	527	
23C		3.5
Tensile Creep Modulus (1h), MPa	899	1,800
IMPACT	ISO Test Method	Property Value
Charpy Notched, kJ/m <sup>2</sup>	179	
23C		4
-30C		4
Charpy Unnotched, kJ/m <sup>2</sup>	179	
23C		50
THERMAL	ISO Test Method	Property Value
Melting Point, C	3146	223
HDT A, C	75	60
Coef. of Linear Thermal Expansion, Parallel,		0.55 X10-4
mm/mm C		
ELECTRICAL	ISO Test Method	Property Value
Comparative Tracking Index	IEC 60112	250
Volume Resistivity	IEC 60093	>1E13
Surface Resistivity	IEC 60093	1E13
Dielectric Constant (100 Hz)	IEC 60250	3.3
Dielectric Constant (1 MHz)	IEC 60250	3.3





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Dissipation Factor (100 Hz)	IEC 60250	110
Dissipation Factor (1 MHz)	IEC 60250	170
UL RATINGS	UL Test Method	Property Value
Flammability Rating, 1.5mm	UL94	V-0
Relative Temperature Index, 1.5mm	UL746B	
Mechanical w/o Impact, C		140
Mechanical w/ Impact, C		130
Electrical, C		125

### **Processing Guidelines**

# Material Handling

Max. Water content: 0.04%

To ensure optimum part performance, this product must be dried prior to molding and maintained at a moisture level of less than 0.04%. Dehumidifying or desiccant dryers operating at 100-120 degC (212-248 degF) at 4 hours drying time is recommended. Further information concerning safe handling procedures can be obtained from the Material Safety Data Sheet. Alternatively, please contact your BASF representative.

#### **Typical Profile**

Melt Temperature 250-270 degC (482-518 degF) Mold Temperature 40-80 degC (104-176 degF) Injection and Packing Pressure 35-125 bar (500-1500 psi)

#### Mold Temperatures

This product can be processed over mold temperatures of 40-80 degC (104-176 degF), although 80 degC (176 deg F) will result the best surface.

#### Pressures

Injection pressure controls the filling of the part and should be applied for 90% of ram travel. Packing pressure affects the final part and can be used effectively in controlling sink marks and shrinkage. It should be applied and maintained until the gate area is completely frozen off.

Back pressure can be utilized to provide uniform melt consistency and reduce trapped air and gas. A maximum of 10 bar (145 psi) is recommended due to the risk of excessive shear.

#### Fill Rate

Fast fill rates are recommended to ensure uniform melt delivery to the cavity and prevent premature freezing. Surface appearance is directly affected by injection rate.



